

# N-Channel MOSFET

## 100V 88A 66W DFN5X6

MFT10N88D56

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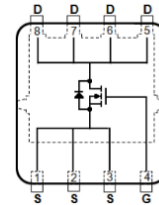
### FEATURE

- $R_{DS(ON)} < 4.2m\Omega$ ,  $V_{GS}=10V$ ,  $I_D=20A$
- High Power and Current Handling Capability
- Super High Dense Cell Design for Extremely Low  $R_{DS(ON)}$



### MECHANICAL DATA

- Case: Molded Plastic, DFN5060 Package
- Terminal: Solderable per MIL-STD-750, Method 2026

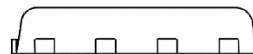
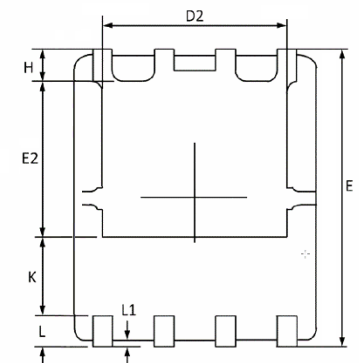
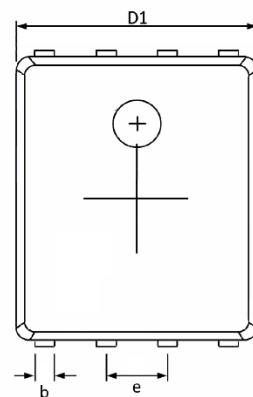


### MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Drain-Source Voltage	$V_{DS}$	100	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Drain Current – Continuous	at $R_{\theta JA}$	27	A
	at $R_{\theta JC}$	88	A
Drain Current – Pulsed	at $R_{\theta JA}$	108	A
	at $R_{\theta JC}$	352	A
Single Pulsed Avalanche Current	$I_{AS}$	60	A
Single Pulsed Avalanche Energy	$E_{AS}$	180	mJ
Maximum Power Dissipation	$P_D$	66	W
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	20	$^{\circ}C/W$
Thermal Resistance, Junction to Case	$R_{\theta JC}$	1.9	$^{\circ}C/W$
Operating Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 to 150	$^{\circ}C$

### DIMENSIONS

Item	Min (mm)	Max (mm)
A	0.80	1.10
b	0.33	0.51
C	0.20	0.30
D1	4.80	5.10
D2	3.61	4.10
E	5.90	6.20
E1	5.70	5.90
E2	3.35	3.78
e	1.27BSC	
H	0.41	0.70
K	1.10	1.50
L	0.51	0.71
L1	0.06	0.20



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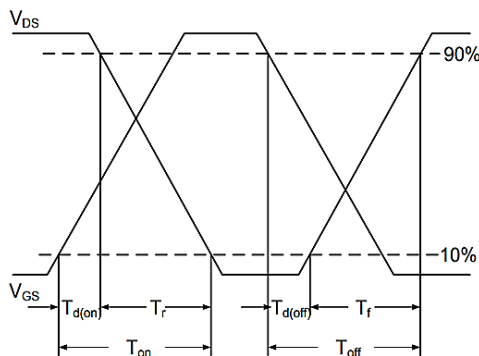
### ELECTRICAL CHARACTERISTICS

Off Characteristics	Conditions	Symbol	Min	Typ.	Max	Unit
Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = 250\mu A$	$BV_{DSS}$	100	--	--	V
Drain-Source Leakage Current	$V_{DS} = 100V, V_{GS} = 0V$	$I_{BSS}$	--	--	1	$\mu A$
Gate Leakage Current, Forward	$V_{GS} = 20V, V_{DS} = 0V$	$I_{GSSF}$	--	--	100	nA
Gate Leakage Current, Reverse	$V_{GS} = -20V, V_{DS} = 0V$	$I_{GSSR}$	--	--	-100	nA
On Characteristics	Conditions	Symbol	Min	Typ.	Max	Unit
Static Drain-Source On-Resistance	$V_{GS} = 10V, I_D = 20A$	$R_{DS(ON)}$	--	3.6	4.2	m $\Omega$
Gate Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250\mu A$	$V_{GS(th)}$	2	--	4	V
Dynamic Characteristics	Conditions	Symbol	Min	Typ.	Max	Unit
Total Gate Charge	$V_{DS} = 80V, V_{GS} = 10V, I_D = 20A$	$Q_g$	-	71	-	nC
Gate-Source Charge		$Q_{gs}$	-	14	-	nC
Gate-Drain Charge		$Q_{gd}$	-	36	-	nC
Turn-On Delay Time	$V_{DS} = 80V, V_{GS} = 10V, R_G = 6\Omega, I_D = 20A$	$T_{d(on)}$	-	46	-	ns
Rise Time		$T_r$	-	34	-	ns
Turn-Off Delay Time		$T_{d(off)}$	-	58	-	ns
Fall Time		$T_f$	-	32	-	ns
Input Capacitance	$V_{DS} = 50V, V_{GS} = 0V, f = 1MHz$	$C_{iss}$	-	2615	-	pF
Output Capacitance		$C_{oss}$	-	750	-	pF
Reverse Transfer Capacitance		$C_{rss}$	-	43	-	pF
Drain-Source Body Diode	Conditions	Symbol	Min	Typ.	Max	Unit
Diode Forward Current-Continuous	--	$I_S$	--	--	55	A
Diode Forward Voltage	$V_{GS} = 0V, I_S = 10A$	$V_{SD}$	--	--	1.2	V

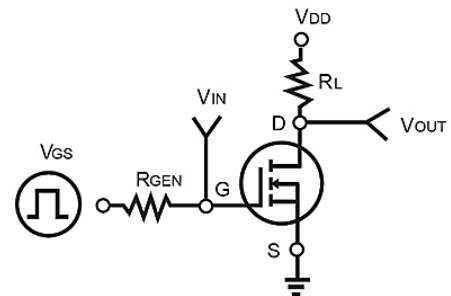
Note:

1. Repetitive Rating: Pulse width limited by maximum junction temperature
2. Surface Mounted on FR4 Board,  $t \leq 10$  sec.
3. Pulse Test: Pulse Width  $\leq 300\mu s$ , Duty Cycle  $\leq 2\%$
4. Guaranteed by design, not subject to production testing
5.  $L = 0.1mH, I_{AS}=60A, V_{DD}=50V, R_G=25\Omega$ , Starting  $T_J=25^\circ C$

Switching Time Waveform



Switching Test Circuit



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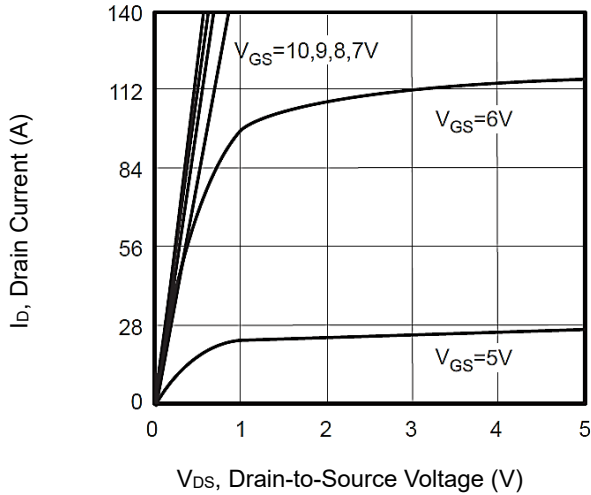
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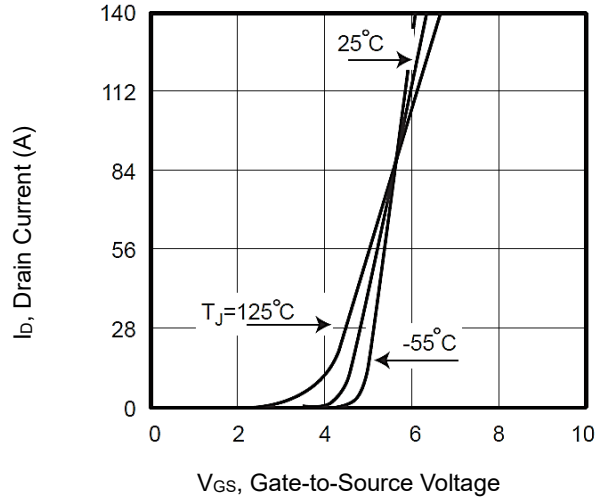
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### CHARACTERISTICS CURVES

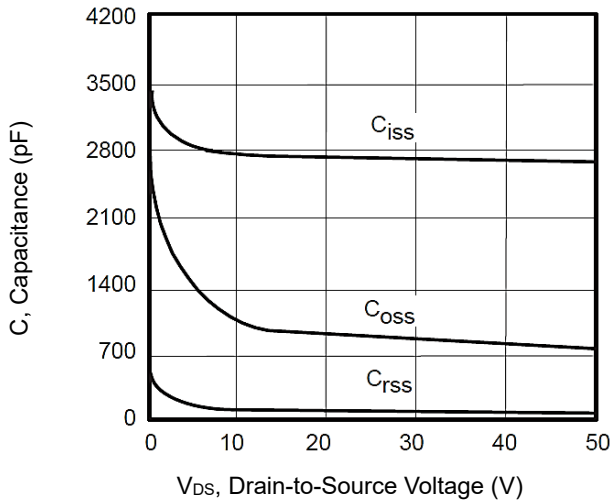
Output Characteristics



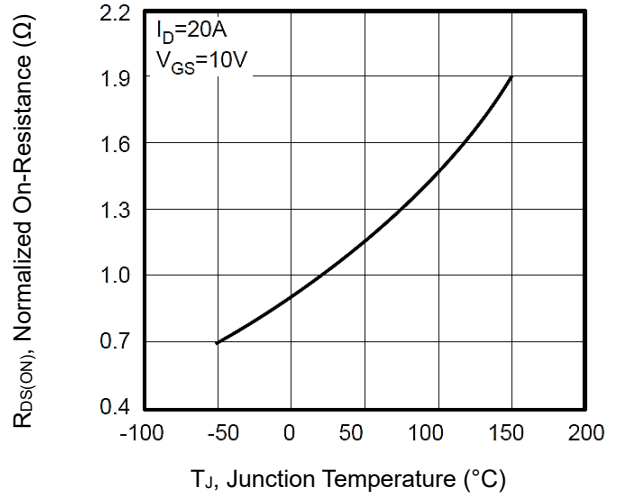
Transfer Characteristics



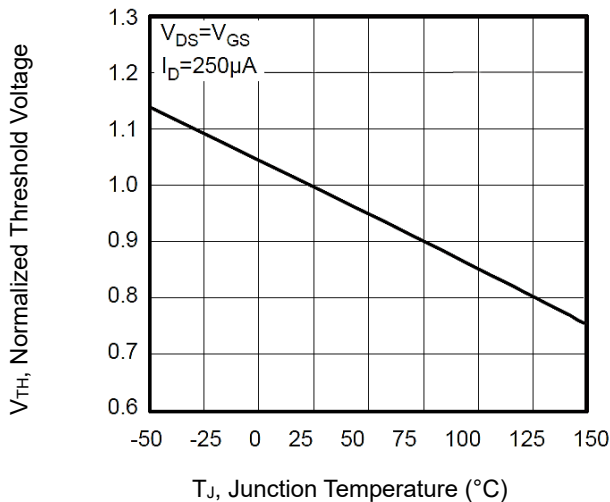
Capacitance



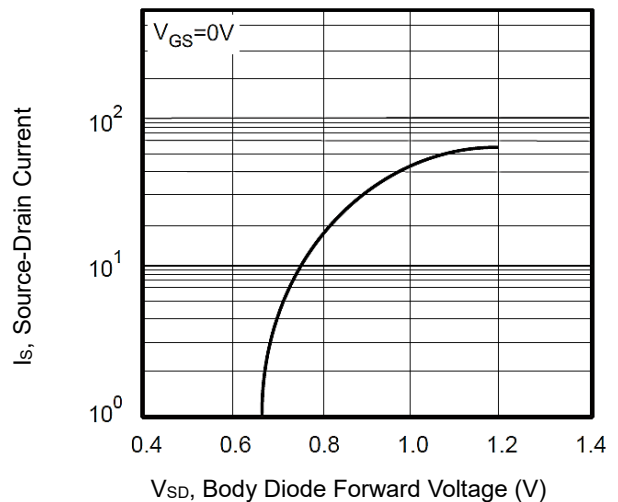
On-Resistance Variation with Temperature



Gate Threshold Voltage with Temperature



Body Diode Characteristics



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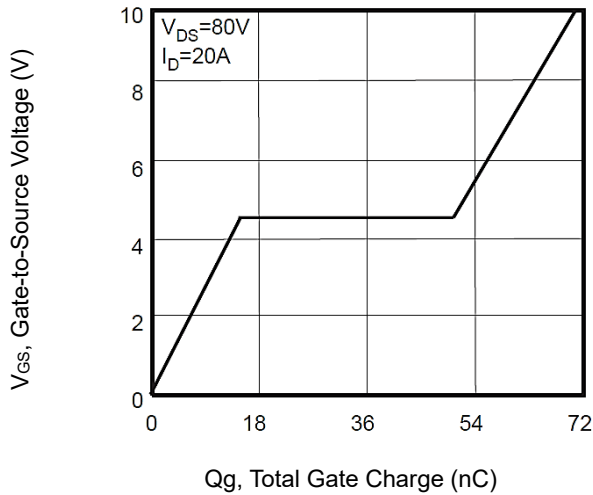
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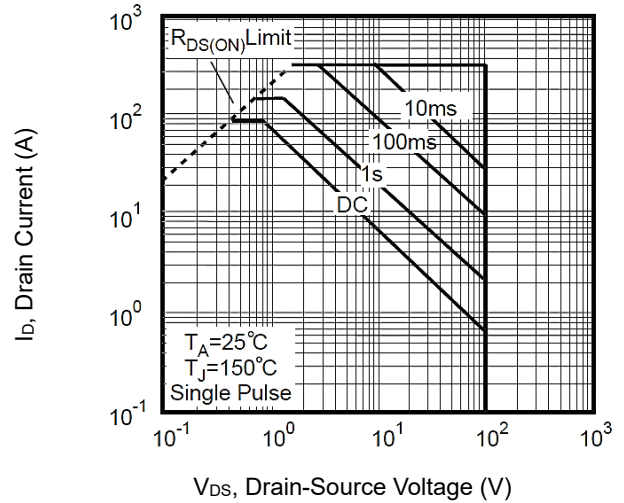
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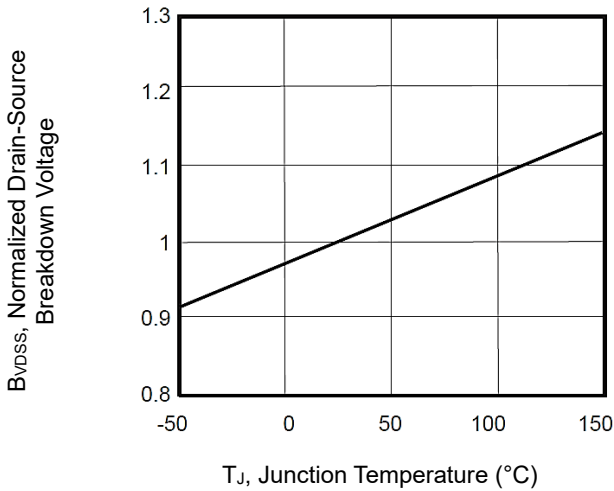
Gate Charge



Maximum Safe Operating Area



Breakdown Voltage Variation with Temperature



Transient Thermal Response Curves

